L Number	Hits	Search Text	DB	Time stamp
1	47	(capacitor near (upper top) near electrode) near5 (spacer sidewall)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:35
2	23	(capacitor near (upper top) near electrode) near5 spacer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:46
3	6	capacitor near (upper top) near electrode near spacer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:48
4	1	spacer near capacitor near (upper top) near electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:49
5	6	capacitor with ((upper top) near electrode near spacer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:52
6	24	capacitor$1 and ((upper top) near electrode near spacer$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 09:53
7	5	("6011284" | "6144060" | "6201726" | "6242299" | "6396092").PN.	USPAT	2004/06/17 09:55
8	24	("4145803" | "4481283" | "4890191" | "5037773" | "5053917" | "5099305" | "5138411" | "5182232" | "5187638" | "5227855" | "5241201" | "5278091" | "5293510" | "5349494" | "5366920" | "5369296" | "5418180" | "5429972" | "5443688" | "5444013" | "5495117" | "5555486" | "5595928" | "5612082").PN.	USPAT	2004/06/17 09:59
9	36	("4145803" | "4481283" | "4890191" | "5037773" | "5053917" | "5099305" | "5138411" | "5182232" | "5187638" | "5217914" | "5223448" | "5227855" | "5241201" | "5278091" | "5293510" | "5349494" | "5366920" | "5369296" | "5418150" | "5418180" | "5429972" | "5443688" | "5444013" | "5495117" | "5555486" | "5595928" | "5612082" | "5696017" | "5741722" | "5793076" | "5940676" | "6037206" | "6066528" | "6077737" | "6080621" | "6083788").PN.	USPAT	2004/06/17 10:04

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L Number	Hits	Search Text	DB	Time stamp
1	2	("6043526").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 16:20
2	160	etch$ with (gas$2 near5 (CHF3 CF4 Ar N2) near5 ((insulat$3 dielectric) near (layer film)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:39
3	27	(etch$ with (gas$2 near5 (CHF3 CF4 Ar N2) near5 ((insulat$3 dielectric) near (layer film)))) and (capacitor$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:01
6	19	stack$3 near2 (conduct$3 adhesive) near2 ((lower bottom) near electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 17:57
7	2413	(conduct$3 adhesive) near2 ((lower bottom) near electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:01
8	0	(conduct$3 adhesive) near2 (before near stack$3) near2 ((lower bottom) near electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 17:58
9	8	(conduct$3 adhesive) near2 before near2 ((lower bottom) near electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 17:59
10	1387	((conduct$3 adhesive) near2 ((lower bottom) near electrode)) and (capacitor$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:01
11	117	adhesive near2 ((lower bottom) near electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:01
12	73	(adhesive near2 ((lower bottom) near electrode)) and (capacitor$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:02
13	27	etch$ with (gas$2 near5 (O2 oxygen CHF3 CF4 Ar N2) near5 ((top upper) near electrode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:41
14	26	etch$ with (gas$2 near5 (O2 oxygen Cl2 BCl3 Ar HBr) near5 ((top upper) near electrode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/17 18:41

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